



NOTES:

- NOTES:
1. Assembly to meet IPC-A-610 Class 2 standards
  2. Modules U14, U16 have special requirements, as listed in the included Bosch BMP388 Handling & Soldering Guidelines. Most important requirements are...
    - a. must not be soldered using a vapor-phase process,
    - b. hole in top of casing must be covered during any liquid or aerosol process (such as cleaning) by a piece of polyimide tape or similar,
    - c. stencil thickness should cause the package to sit at least 50 um off the PCB surface after soldering
  3. Polarity marks:
    - a. Dots and bevels near ICs and modules indicate pin 1
    - b. '+' symbols near polarized capacitors indicate positive terminal
    - c. Bands near diodes indicate cathode, although standard diode symbols are used wherever possibleIf polarity issues arise, please e-mail for clarification (understood that this may delay order)
  4. No through-hole components (J\*, BT\*) are to be populated
  5. U31 and U33 are overlapping footprints for alternate part options: only U33 is to be populated